



Notes from the NEDA Roundtable in Memphis October 20 & 21, 2005

All,

I'm sure you recorded more action items than I did and I'm sure I am missing someone from the attendee list. Please forward them to me so I can update this list.

Attendees

Full Individual Name	Org Name	Full Individual Name	Org Name
Aaron Edwards	TT Electronics	Mr. Jay Smith	Future Electronics, Inc.
Arnold Offner	Phoenix Contact	Mr. Jerry Seinturier	Bourns, Inc.
Bruce Moser	Arrow Electronics, Inc.	Mr. Jim Ingersoll	RS Electronics
Chris Reynolds	AVX	Mr. Merrill Mahoney	Sager Electronics
David Richardson	Vishay	Mr. Rodney L. Spear	TTI, Inc.
Donald E. Elario, Jr.	Arrow Electronics, Inc.	Mr. Vincent Ciccolo	Analog Devices, Inc.
Ferdie Alviz	E/W Electronics	Ms. Melanie Pizzey	TTI, Inc.
Jeff Beatty	Optek Technology, Inc.	Patricia Smith	Future Electronics
Jeff Shafer	Newark InOne	Pete Shopp	Mouser Electronics
Jerry Czerwonka	Avnet, Inc.	Piero Fagiolo	Ohmite Manufacturing Co.
Leonard A. Metzger	Panasonic Industrial Co.	Robert Derringer	Dialight Corp.
Mary Carter Berrios	KEMET Electronics Corp.	Robert M. Taflinger	BI Technologies Corp.
Michael E. Griffith	Koa Speer Electronics, Inc.	Shannon Freise	Sager Electronics
Michelle Graves	Allied Electronics, Inc.	Ty Golden	TTI, Inc.
Mike Williams	Mouser Electronics		
Mr. Anthony Wong	National Semiconductor Corp.		
Mr. Bruce Gerig	Texas Instruments		
Mr. Gilbert Alcaraz	National Semiconductor Corp.		

- Create a lessons learned out of the RoHS Lead free activities like working with other standards organizations, not working fast enough, standards vs. guidelines, earlier standards
- Caution on data confidentiality – Watch where your data goes
- Procedure for forwarding confidential data – standard statement
- Task force to create guideline (Rod Spear, Gil Alkeriz, Don Elario, Arnold Offner, Michael Griffith, Dan , Michelle Graves, Shannon Freise, Jay Smith)
 - Identify what the RoHS Label is and how to use it
 - Material declaration 1751 & 1752 standard support
 - Material declaration pitfalls

- Standard compliance statement
- What about a certification for green manufacturing and eliminating the need for material declaration
- Jay to conduct a teleconference to update spreadsheet with new columns
- Presentation by Michael Griffith on his shelf life tests (Michael to send data for the group??)
 - What is the best way to use this valuable data?
- Presentation from JB Holister on automated Excel spreadsheets

Import Export Committee

- Publish quarterly newsletter in the NEDA news
- Get more active component manufacturers in the group
- Add the Import Export committee to the website
- Send out the survey again
- Get contacts to Tricia

Components Roundtable Actions From the Spring 2005 meeting

- Incorporate a RoHS label identification into industry standards - **Barney**
 - JEDEC
 - IPC
 - NEDA Guideline
 - **JEDEC adding a RoHS identification to JEP 113**
- Material Content declaration
 - IPC forms 1751 and 1752
 - **Lots of activity and delays. Mary Carter_berrios to monitor and update us at next meeting.**
- Labeling issues – **Dan Wikander**
 - 1D/2D paper
 - Creation/update labeling guideline
 - Combine various labeling standards and add supply chain requirements
 - Coordinate with INEMI
 - Date code format
 - Lot code
 - RoHS
 - Country of origin

- Lead Free
- Packaging
 - New guideline for packaging and handling
 - Review packaging materials requirements in light of WEEE
- Date Code Issues
 - Effects that RoHS/Lead Free will have on date code restrictions
 - Continuing to push relaxation of date code issues with test data
 - Coordinate with Solder Technology Group
- Review and update NEDA Guidelines – **Rod Spear**
- Update POS and Demand Creation forms – **Barney to establish a NEDA taskgroup to update forms**
- Certificate of Compliance for RoHS/Lead Free – **Barney to review AFDEC recommendations**